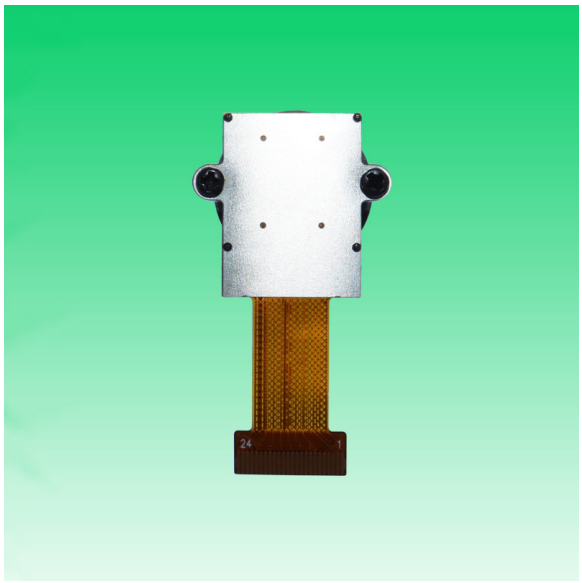
KLT-Z3MF-IMX415 V1.0

8.46MP Sony IMX415 MIPI Interface M12 Fixed Focus Camera Module

Front View



Back View

Specifications

Camera Module No.	KLT-Z3MF-IMX415 V1.0
Resolution	8.46MP
Image Sensor	IMX415
Sensor Type	1/2.8"
Pixel Size	1.45 um x 1.45 um
EFL	2.02 mm
F.NO	2.50
Pixel	3864 x 2228
View Angle	118.8°(DFOV) 109.9°(HFOV) 74.6°(VFOV)
Lens Dimensions	15.30 x 15.30 x 21.17 mm
Module Size	40.00 x 22.00 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Model	KLT-LENS-TRC-20805A26-01
Lens Type	650nm IR Cut
Operating Temperature	-30°C to +85°C
Mating Connector	FH12-24S-0.5SH

www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

KLT-Z3MF-IMX415 V1.0

8.46MP Sony IMX415 MIPI Interface M12 Fixed Focus Camera Module

Top View

Side View

Bottom View

Mating Connector

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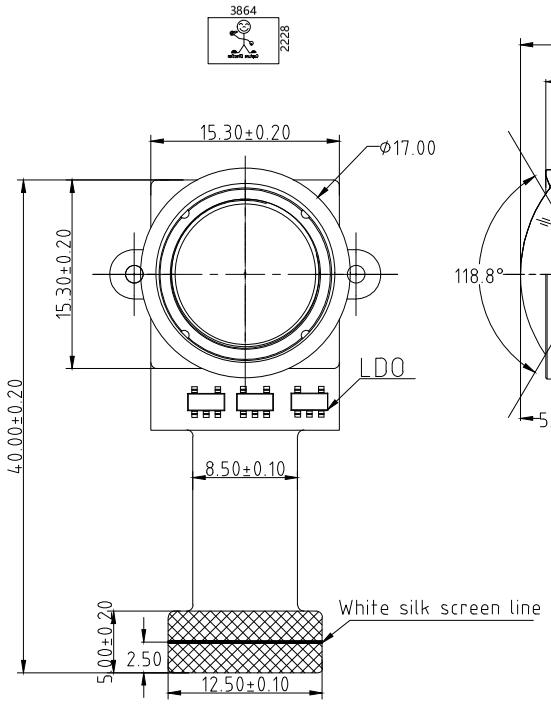
ROHS

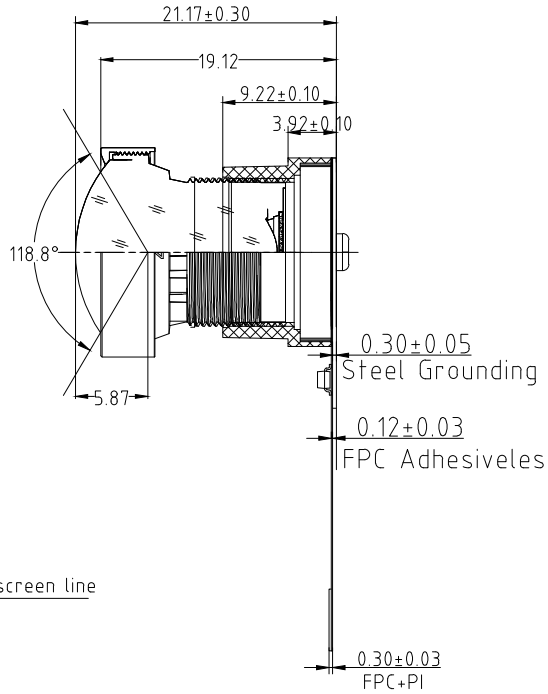
Version	Information	Date
V1.0	First Version	4-1-2022

RoHS

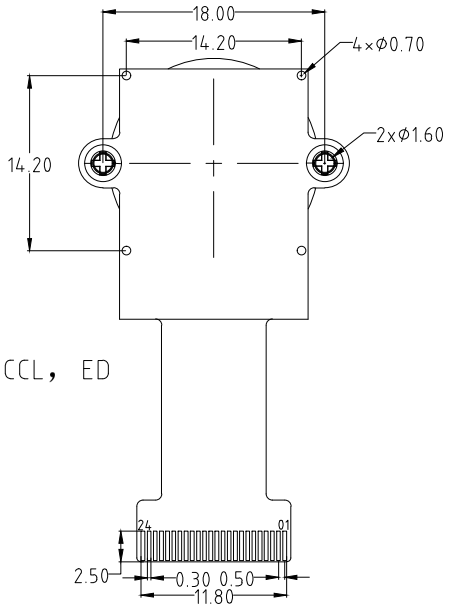
PIN	SIGNAL
1	GND
2	GND
3	NC
4	RESET
5	SDA
6	SCL
7	GND
8	GND
9	MDN0
10	MDP0
11	MDN1
12	MDP1
13	MDN2
14	MDP2
15	MDN3
16	MDP3
17	GND
18	MCN
19	MCP
20	GND
21	MCLK
22	VCC 3.3V
23	VCC 3.3V
24	VCC 3.3V



TOP VIEW



SIDE VIEW



BOTTOM VIEW

Parameters:

1、Sensor specification:

Image Sensor: IMX415
Pixel: 1.45um×1.45um
Lens Type: 1/2.8
Important Voltage Description: DVDD1.1V (external power supply);

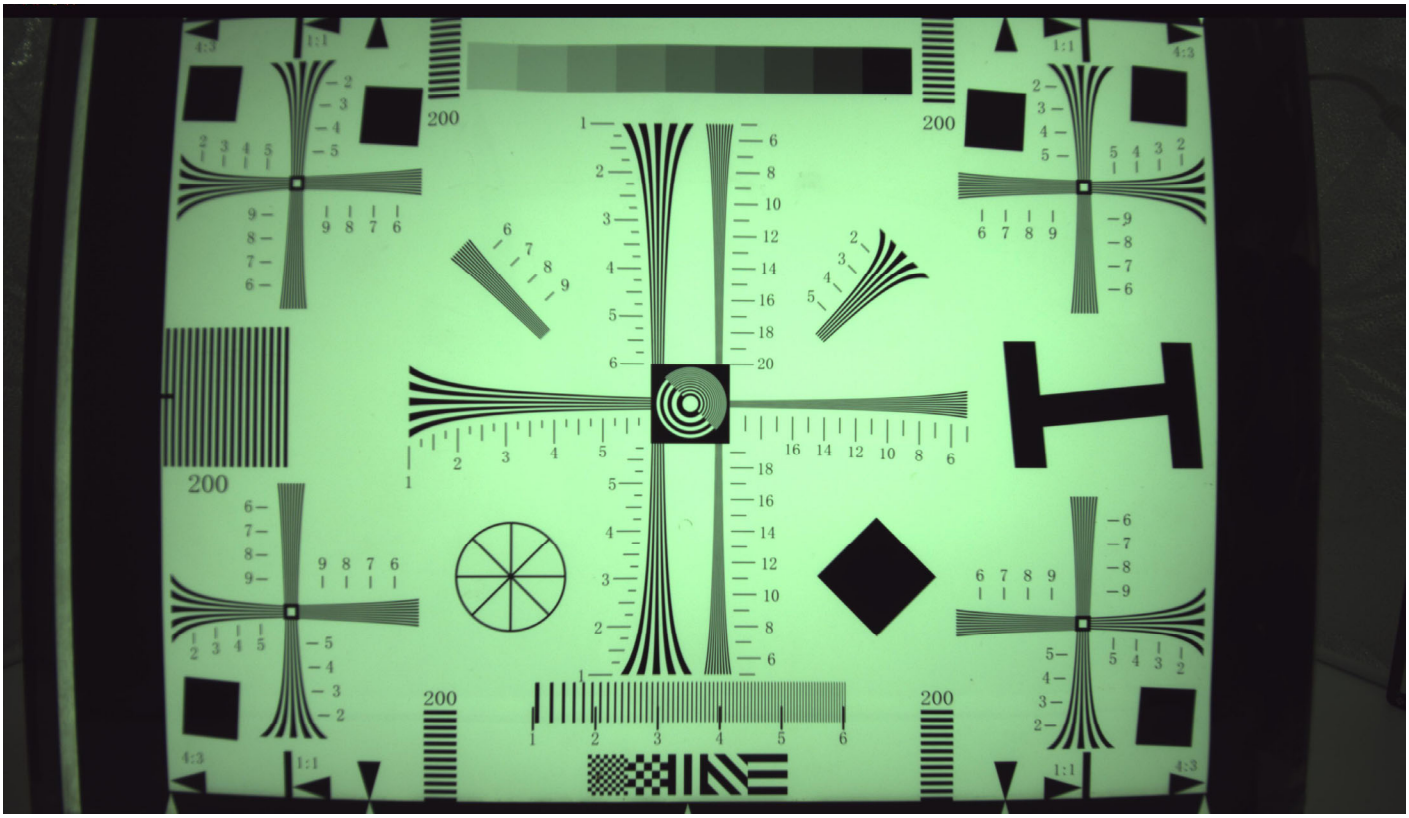
2、Lens specification:

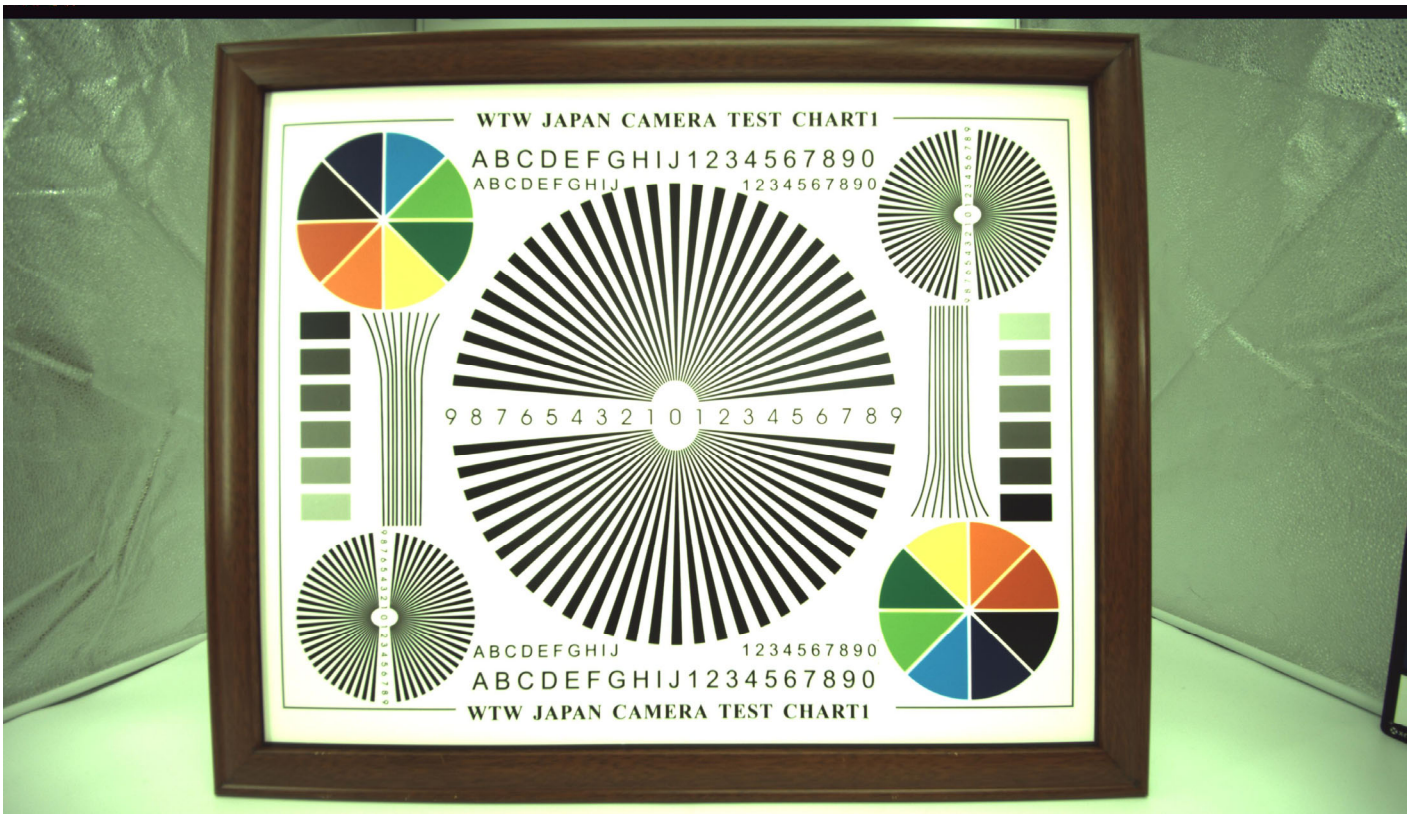
FOV: 118.8°(D);109.9°(H);74.6°(V);
F/NO.: 2.5
TV distortion: <-3.6%
Focal length: 2.02mm
Composition: 2G4P+I+IR FILTER
IR Cut Coating: 650nm±10nm@50%

Kai Lap Technologies Group Ltd

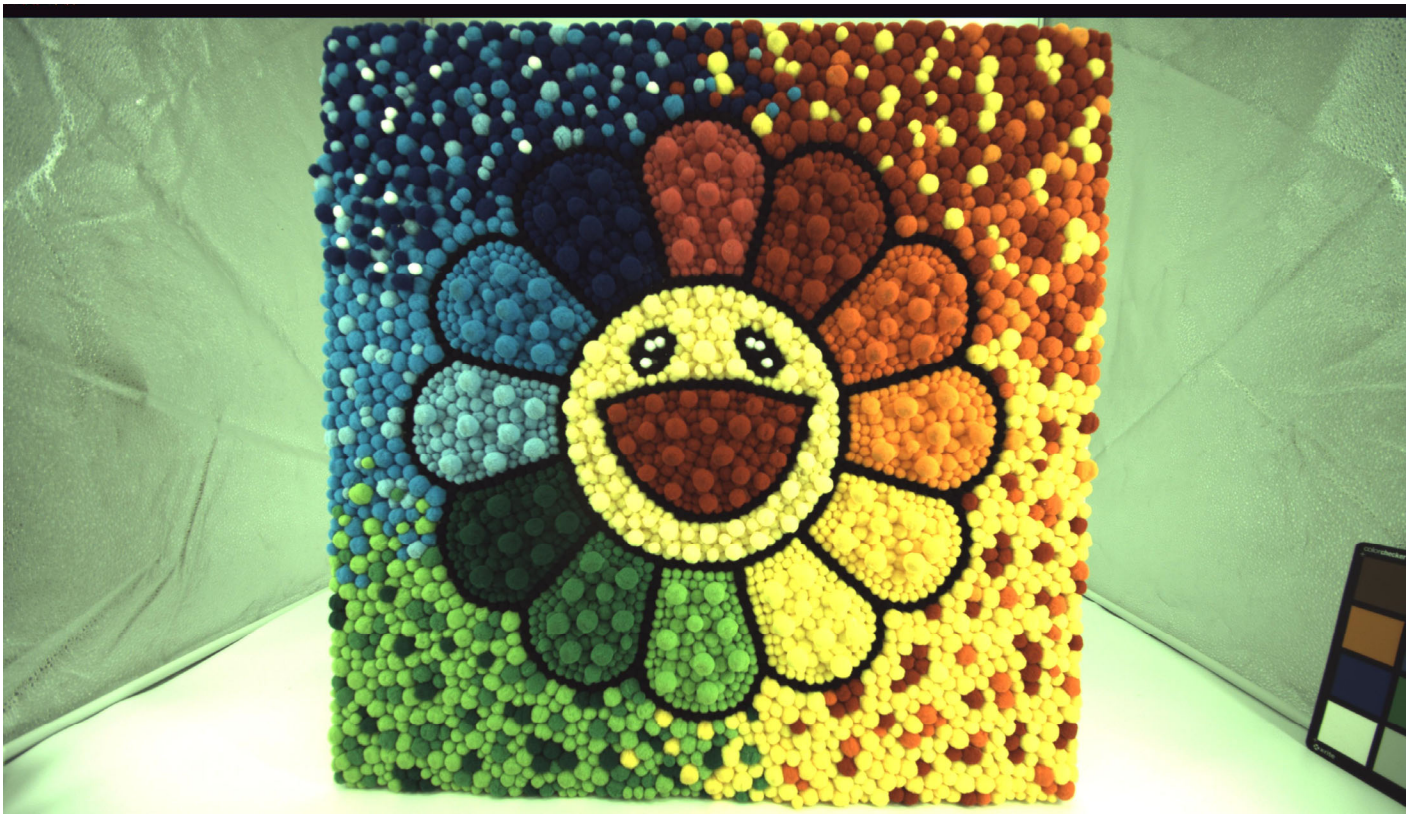
Designed By	Kevin	Model Name:	KLT-Z3MF-IMX415 V1.0
Checked By	Aouly Yan	Projection Type: Third Angle	Unit: mm / Material: ---------- / Scale: 1:1 / Sheet: 1 of 1 / Version: 1/0

Real Test Images
Z3MF-IMX415 V1.0

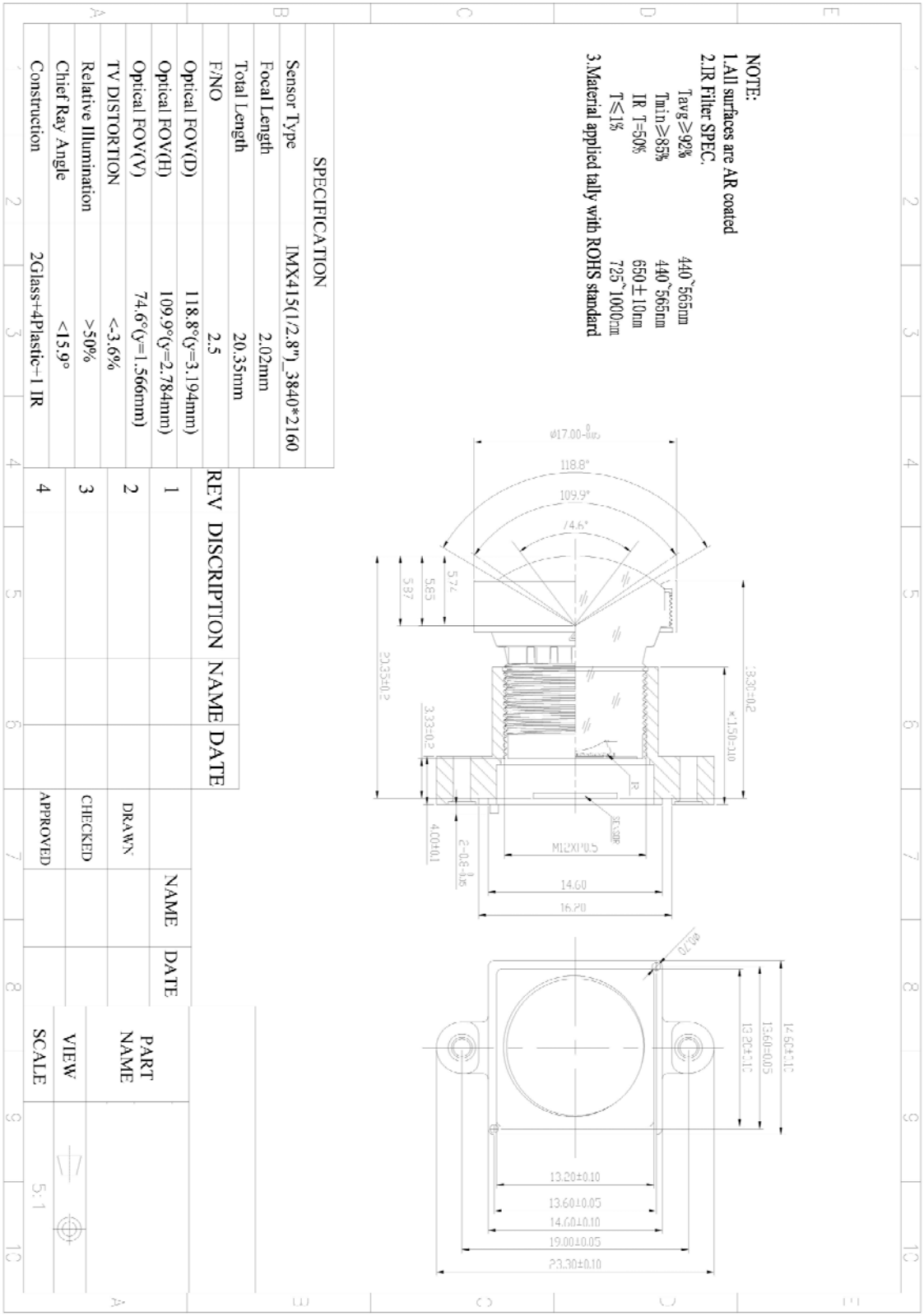




Real Test Images
Z3MF-IMX415 V1.0

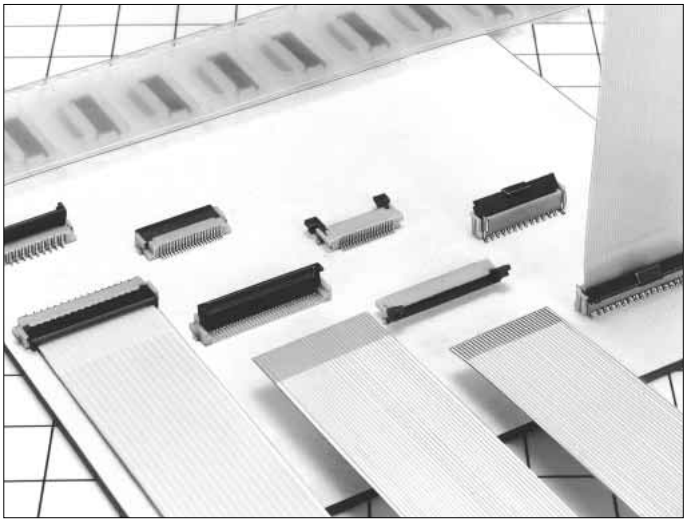


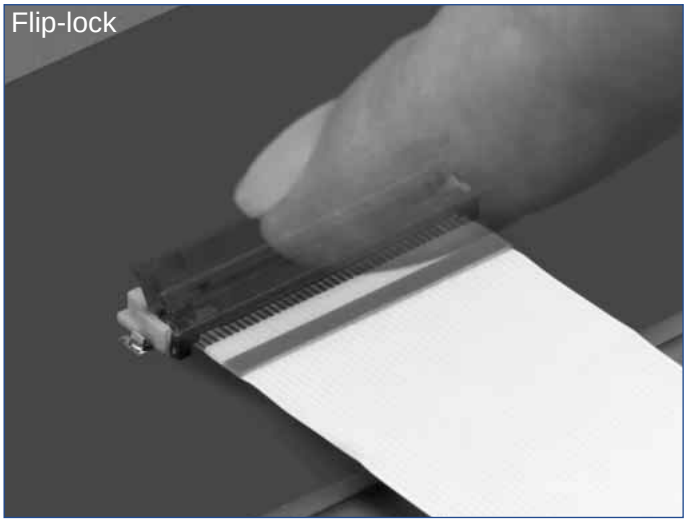
Lens Model: KLT-LENS-TRC-20805A26-01



0.5mm and 1mm Pitch Connectors For FPC/FFC

FH12 Series





■Features

1. Ease of Use and Space Savings

Only one finger or 6.9N (Newtons) of force is required to lock Hirose's rotational actuator (flip-lock) as compared to using 2 fingers and 39.2N to close a FFC/FPC connector from our competition.

The Flip-Lock design also allows customers to place 2 or more connectors side by side as there is no need to waste additional board space for a side latch.

2. Strengthened Flip-lock Actuator

The standard Flip-Lock requires only 2.0mm height above the board. A strengthened lock lever is available which only requires an additional 0.4mm.

3. Supports Thin FPC (0.18mm)

Hirose does not require double-sided FPC to have any additional strengthening plate or stiffener and can therefore support a thickness of as little as 0.18mm +/- 0.05.

4. Hirose Ensures Reliability

Hirose's patented half tuning fork contacts maintain the required normal force without relying on the connector housing. With our competitor's conventional products the housing walls support the contact force, which does not provide for long-term reliability.

5. Prevention of Solder Bridge

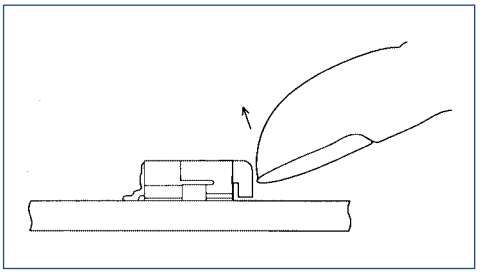
Excess solder cavity absorbs excessive solder and avoids solder bridging.

6. Three different assembly types

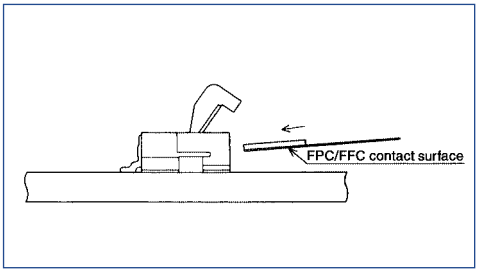
FH12 is offered in Top & Bottom Contact and Vertical Mount and offered in both a 0.5mm contact pitch as well as a 1.0mm contact pitch (bottom contact only).

Rotating One-touch Mechanism

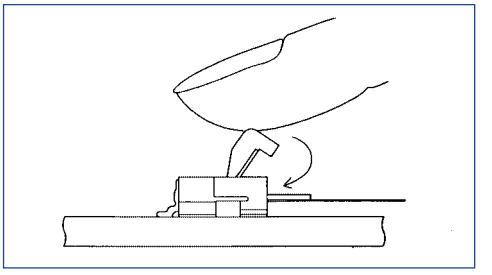
①



②



③



■Applications

Notebook computers, printers, PDAs, digital cameras and other compact devices for interconnecting the main circuit board with the LCD, HDD or other device.

■Product Specifications

Rating	Current rating: 0.5A DC(Note 1) Voltage rating: 50V AC	Operating Temperature Range:−40 to +70℃ (Note 2) Operating Humidity Range:Relative humidity, 90% max. (Not dewed)	Storage Temperature Range:−10 to +50℃ (Note 3) Storage Humidity Range:Relative humidity, 90% max. (Not dewed)

Applicable FPC	t=0.3±0.05 Gold plated	t=0.18 ± 0.05 for FH12F-∗S-0.5SH

Item	Specification	Conditions
1. Insulation resistance	500M ohms minimum	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	150V AC/1 minute
3. Contact resistance	50m ohms maximum	1mA
4. Durability (Insertion/withdrawal)	Contact resistance: 50m ohms maximum No damage, cracks, or parts dislocation.	20 cycles
5. Vibration	No electrical discontinuity of 1μs or more Contact resistance: 50m ohms maximum. No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours in each of the 3 directions.
6. Shock	No electrical discontinuity of 1μs or more Contact resistance: 50m ohms maximum. No damage, cracks, or parts dislocation.	Acceleration of 490 m/s², 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
7. Humidity(Steady state)	Contact resistance: 50m ohms maximum. Insulation resistance: 50M ohms minimum. No damage, cracks, or parts dislocation.	96 hours at 40℃ and humidity of 90% to 95%
8. Temperature Cycle	Contact resistance: 50m ohms maximum. Insulation resistance: 50M ohms minimum. No damage, cracks, or parts dislocation.	Temperature: -40℃ → 15 to 35℃ → 85℃ → 15 to 35℃, Time: 30 → 5 max. → 30 → 5 max.(minutes) 5 cycles
9.Resistance to Soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350±5℃ for 3 seconds

Note 1: When passing the current through all of the contacts,use 70% of the current rating.
Note 2: Includes temperature rise caused by current flow.
Note 3: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers nonconducting condition of installed connectors in storage, shipment or during transportation.

■Material

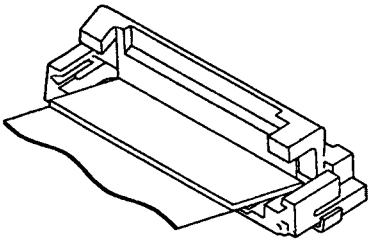
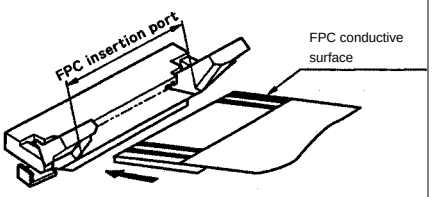
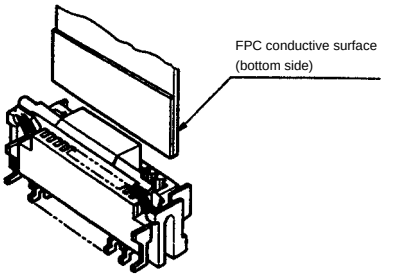
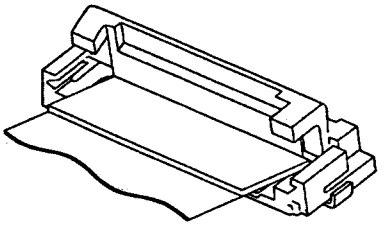
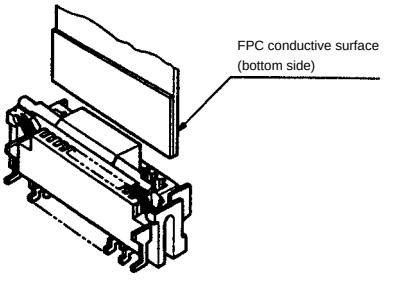
Part	Material	Finish	Remarks
Insulator	Polyamide, LCP(60 pos.)	Color : Beige	UL94V-0
Actuator	PPS	Color : Dark brown	
Contact	Phosphor bronze	Gold plated	———
Metal Fittings	Brass	Tin plated	

■Ordering Information

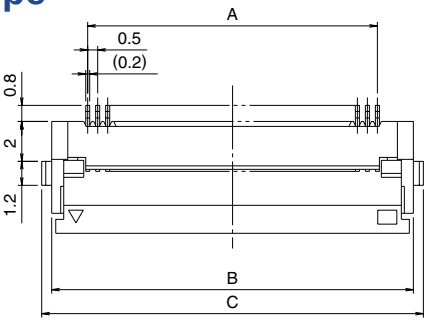
FH12 A - 10 (4) - S A - 0.5 SH (55)
❶ ❷ ❸ ❹ ❺ ❻ ❼ ❽ ❾

❶ Series Name : FH12	❺ Contact alignment: Single
❷ Blank : standard type A : Top contact type S : Type with strengthed flip-lock actuator F : Type with 0.18mm FPC End Thickness	❻ Eccentric direction: Blank : standard type A : Eccentric type
	❼ Contacts Pitch : 0.5mm, 1mm
❸ Standard type : Number of contacts Eccentric type : Number of contacts in 0.5mm housing	❽ Contact type SH : SMT horizontal mounting type SV : SMT vertical mounting type
❹ Standard type : Blank Eccentric type : Number of contacts	❾ Plating specification (55) : Gold plated

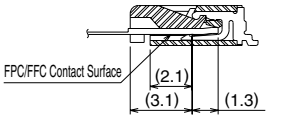
Series Configuration

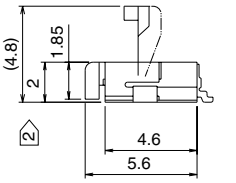
Pitch	Bottom Contact Type	Top Contact Type	Vertical mounting Type
0.5mm	 **FH12- ** S-0.5SH** P.12 Number of contacts 6, 8, 10, 11, 12, 13, 14, 15, 16, 17, 18, 19, 20, 22, 24, 25, 26, 28, 30, 32, 33, 34, 35, 36, 40, 45, 50, 53 Type with Strengthened Lock Lever **FH12S- ** S-0.5SH** P.13 Number of contacts 30, 40, 45, 50, 53 Type with 0.18mm FPC End Thickness **FH12F- ** S-0.5SH** P.14 Number of contacts 6, 8, 10, 12, 13, 14, 15, 16, 18, 20, 22, 24, 25, 26, 28, 30, 32, 34, 36, 40	 **FH12A- ** S-0.5SH** P.15 Number of contacts 10, 12 ,15, 16, 18, 20, 22, 24, 26, 28, 29, 30, 32, 33, 34, 36, 40, 42, 45, 50	 **FH12- ** S-0.5SV** P.16 Number of contacts 10, 12, 13, 15, 16, 17, 18, 20, 22, 24, 26, 30, 32, 33, 34, 36, 40, 45, 49, 50, 60
1mm	 Standard **FH12- ** S-1SH** P.18 Eccentric **FH12- ** (**) SA-1SH** Standard Number of contacts 5, 6, 7, 8, 9, 11, 12,16,17,22,26 Eccentric Number of contacts 4, 6, 8, 10, 11, 14, 19, 24		 **FH12- ** S-1SV** P.19 Number of contacts 6, 7, 8, 16, 20, 22, 24

■0.5mm Pitch Bottom Contact Type



Mated Cross-sectional Diagram





Unit:mm

	Part Number	CL No.	Number of Contacts	A	B	C	D	RoHS
	FH12- 6S-0.5SH(55)	586-0582-5-55	6	2.5	6.1	7.1	3.57	YES
	FH12- 8S-0.5SH(55)	586-0744-5-55	8	3.5	7.1	8.1	4.57	
	FH12-10S-0.5SH(55)	586-0522-3-55	10	4.5	8.1	9.1	5.57	
	FH12-11S-0.5SH(55)	586-0600-5-55	11	5	8.6	9.6	6.07	
	FH12-12S-0.5SH(55)	586-0704-0-55	12	5.5	9.1	10.1	6.57	
	FH12-13S-0.5SH(55)	586-0549-0-55	13	6	9.6	10.6	7.07	
	FH12-14S-0.5SH(55)	586-0533-0-55	14	6.5	10.1	11.1	7.57	
	FH12-15S-0.5SH(55)	586-0523-6-55	15	7	10.6	11.6	8.07	
	FH12-16S-0.5SH(55)	586-0531-4-55	16	7.5	11.1	12.1	8.57	
	FH12-17S-0.5SH(55)	586-0606-1-55	17	8	11.6	12.6	9.07	
	FH12-18S-0.5SH(55)	586-0530-1-55	18	8.5	12.1	13.1	9.57	
	FH12-19S-0.5SH(55)	586-0534-2-55	19	9	12.6	13.6	10.07	
	FH12-20S-0.5SH(55)	586-0524-9-55	20	9.5	13.1	14.1	10.57	
	FH12-22S-0.5SH(55)	586-0532-7-55	22	10.5	14.1	15.1	11.57	
	FH12-24S-0.5SH(55)	586-0521-0-55	24	11.5	15.1	16.1	12.57	
	FH12-25S-0.5SH(55)	586-0692-3-55	25	12	15.6	16.6	13.07	
	FH12-26S-0.5SH(55)	586-0576-2-55	26	12.5	16.1	17.1	13.57	
	FH12-28S-0.5SH(55)	586-0612-4-55	28	13.5	17.1	18.1	14.57	
Note 2	FH12-30S-0.5SH(55)	586-0525-1-55	30	14.5	18.1	19.1	15.57	
	FH12-32S-0.5SH(55)	586-0681-7-55	32	15.5	19.1	20.1	16.57	
	FH12-33S-0.5SH(55)	586-0520-8-55	33	16	19.6	20.6	17.07	
	FH12-34S-0.5SH(55)	586-0617-8-55	34	16.5	20.1	21.1	17.57	
	FH12-35S-0.5SH(55)	586-0740-4-55	35	17.0	20.6	21.6	18.07	
	FH12-36S-0.5SH(55)	586-0526-4-55	36	17.5	21.1	22.1	18.57	
Note 2	FH12-40S-0.5SH(55)	586-0527-7-55	40	19.5	23.1	24.1	20.57	
Note 2	FH12-45S-0.5SH(55)	586-0528-0-55	45	22	25.6	26.6	23.07	
Note 2	FH12-50S-0.5SH(55)	586-0529-2-55	50	24.5	28.1	29.1	25.57	
Note 2	FH12-53S-0.5SH(55)	586-0595-7-55	53	26	29.6	30.6	27.07	

Note 1 : Embossed tape reel packaging (2,000 pieces/reel).
Order by number of reels.

Note 2 : If there is no problem with the connector height, we recommend the type with the strengthened Flip-lock actuator (FH12S-✻S-0.5SH).
Standard type connector height: 2 mm
Connector height of type with strengthened Flip-lock actuator: 2.4 mm

SONY

[Product Information]

Ver.1.0

IMX415-AAQR

Diagonal 6.43 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for Color Cameras

Description

The IMX415-AAQR is a diagonal 6.4 mm (Type 1/2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 8.46 M effective pixels. This chip operates with analog 2.9 V, digital 1.1 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. This chip features an electronic shutter with variable charge-integration time.
(Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- ◆ CMOS active pixel type dots
- ◆ Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆ Input frequency: 24 MHz / 27 MHz / 37.125 MHz / 72 MHz / 74.25 MHz
- ◆ Number of recommended recording pixels: 3840 (H) × 2160 (V) approx. 8.29 M pixels
- ◆ Readout mode
  - All-pixel scan mode
  - Horizontal / Vertical 2/2-line binning mode
  - Window cropping mode
  - Horizontal / Vertical direction - Normal / Inverted readout mode
- ◆ Readout rate
  Maximum frame rate in
  All-pixel scan mode: 12 bit: 60.3 frame/s, 10 bit: 90.9 frame/s
- ◆ High dynamic range (HDR) function
  - Multiple exposure HDR
  - Digital overlap HDR
- ◆ Synchronizing sensors function
- ◆ Variable-speed shutter function (resolution 1H units)
- ◆ CDS / PGA function
  0 dB to 30 dB : Analog Gain 30 dB (step pitch 0.3 dB)
  30.3 dB to 72 dB : Analog Gain 30 dB + Digital Gain 0.3 dB to 42 dB (step pitch 0.3 dB)
- ◆ Supports I/O
  CSI-2 serial data output (2 Lane / 4 Lane), RAW10 / RAW12 output
- ◆ Recommended exit pupil distance: –30 mm to –∞

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μm^2 (color product, when imaging with a 706 cd/m^2 light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

Sony reserves the right to change products and specifications without prior notice.
Sony logo is a registered trademark of Sony Corporation.

Device Structure

◆CMOS image sensor	
◆Image size	Diagonal 6.4 mm (Type 1/2.8) approx. 8.40 M pixels, All pixels
◆Total number of pixels	3864 (H) × 2228 (V) approx. 8.60 M pixels
◆Number of effective pixels	3864 (H) × 2192 (V) approx. 8.46 M pixels
◆Number of active pixels	3864 (H) × 2176 (V) approx. 8.40 M pixels
◆Number of recommended recording pixels	3840 (H) × 2160 (V) approx. 8.29 M pixels
◆Unit cell size	1.45 µm (H) × 1.45 µm (V)
◆Optical black	Horizontal (H) direction: Front 0 pixel, rear 0 pixel
	Vertical (V) direction: Front 36 pixels, rear 0 pixel
◆Dummy	Horizontal (H) direction: Front 0 pixel, rear 0 pixel
	Vertical (V) direction: Front 1 pixel, rear 1 pixel
◆Package	114 pin LGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F5.6)	Typ.	2048 Digit	1/30 s accumulation 12 bit converted value
Saturation signal	Min.	3895 Digit	12 bit converted value

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	3840 (H) × 2160 (V) approx. 8.29 M pixels	90.9	CSI-2	10
Horizontal/ Vertical 2/2-line binning	1920 (H) × 1080 (V) approx. 2.07 M pixels	90.9	CSI-2	10

SONY

[Product Information]

Ver.1.0

IMX415-AAMR

Diagonal 6.43 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for Monochrome Cameras

Description

The IMX415-AAMR is a diagonal 6.4 mm (Type 1/2.8) CMOS active pixel type solid-state image sensor with a square pixel array and 8.46 M effective pixels. This chip operates with analog 2.9 V, digital 1.1 V, and interface 1.8 V triple power supply, and has low power consumption. High sensitivity, low dark current and no smear are achieved. This chip features an electronic shutter with variable charge-integration time.
(Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- ◆CMOS active pixel type dots
- ◆Built-in timing adjustment circuit, H/V driver and serial communication circuit
- ◆Input frequency: 24 MHz / 27 MHz / 37.125 MHz / 72 MHz / 74.25 MHz
- ◆Number of recommended recording pixels: 3840 (H) × 2160 (V) approx. 8.29 M pixels
- ◆Readout mode
  - All-pixel scan mode
  - 2 × 2 adjacent pixel binning mode
  - Window cropping mode
  - Horizontal / Vertical direction - Normal / Inverted readout mode
- ◆Readout rate
  Maximum frame rate in
  All-pixel scan mode: 12 bit: 60.3 frame/s, 10 bit: 90.9 frame/s
- ◆High dynamic range (HDR) function
  - Multiple exposure HDR
  - Digital overlap HDR
- ◆Synchronizing sensors function
- ◆Variable-speed shutter function (resolution 1H units)
- ◆CDS / PGA function
  0 dB to 30 dB : Analog Gain 30 dB (step pitch 0.3 dB)
  30.3 dB to 72 dB : Analog Gain 30 dB + Digital Gain 0.3 dB to 42 dB (step pitch 0.3 dB)
- ◆Supports I/O
  CSI-2 serial data output (2 Lane / 4 Lane), RAW10 / RAW12 output
- ◆Recommended exit pupil distance: –100 mm to –∞

STARVIS

* STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 μm^2 (color product, when imaging with a 706 cd/m^2 light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

Sony reserves the right to change products and specifications without prior notice.
Sony logo is a registered trademark of Sony Corporation.

Device Structure

◆CMOS image sensor	
◆Image size	Diagonal 6.4 mm (Type 1/2.8) approx. 8.40 M pixels, All pixels
◆Total number of pixels	3864 (H) × 2228 (V) approx. 8.60 M pixels
◆Number of effective pixels	3864 (H) × 2192 (V) approx. 8.46 M pixels
◆Number of active pixels	3864 (H) × 2176 (V) approx. 8.40 M pixels
◆Number of recommended recording pixels	3840 (H) × 2160 (V) approx. 8.29 M pixels
◆Unit cell size	1.45 µm (H) × 1.45 µm (V)
◆Optical black	Horizontal (H) direction: Front 0 pixel, rear 0 pixel
	Vertical (V) direction: Front 36 pixels, rear 0 pixel
◆Dummy	Horizontal (H) direction: Front 0 pixel, rear 0 pixel
	Vertical (V) direction: Front 1 pixel, rear 1 pixel
◆Package	114 pin LGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks
Sensitivity (F8)	Typ.	1570 Digit	1/30 s accumulation 12 bit converted value
Saturation signal	Min.	3895 Digit	12 bit converted value

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
All pixel	3840 (H) × 2160 (V) approx. 8.29 M pixels	90.9	CSI-2	10
2 × 2 adjacent pixel binning	1920 (H) × 1080 (V) approx. 2.07 M pixels	90.9	CSI-2	10

Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	**Description**
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

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Cameras Applications

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Camera Reliability Test

Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional




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Camera Inspection Standard

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Inspection Item			Inspection Method	Standard of Inspection
Category		Item		
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Gap	The Naked Eye	Meet the Height Standard
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard
		Contamination	The Naked Eye	No Effect On Resolution Standard
		Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
Function	Image	No Communication	Test Board	Not Allowed
		Bright Pixel	Black Board	Not Allowed In the Image Center
		Dark Pixel	White board	Not Allowed In the Image Center
		Blurry	The Naked Eye	Not Allowed
		No Image	The Naked Eye	Not Allowed
		Vertical Line	The Naked Eye	Not Allowed
		Horizontal Line	The Naked Eye	Not Allowed
		Light Leakage	The Naked Eye	Not Allowed
		Blinking Image	The Naked Eye	Not Allowed
		Bruise	Inspection Jig	Not Allowed
		Resolution	Chart	Follows Outgoing Inspection Chart Standard
		Color	The Naked Eye	No Issue
		Noise	The Naked Eye	Not Allowed
		Corner Dark	The Naked Eye	Less Than 100px By 100px
		Color Resolution	The Naked Eye	No Issue
Dimension		Height	The Naked Eye	Follows Approval Data Sheet
		Width	The Naked Eye	Follows Approval Data Sheet
		Length	The Naked Eye	Follows Approval Data Sheet
		Overall	The Naked Eye	Follows Approval Data Sheet

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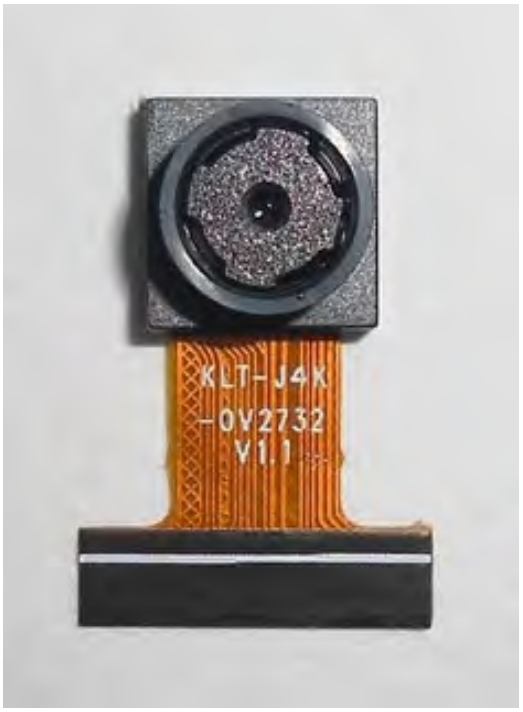
KLT Package Solutions

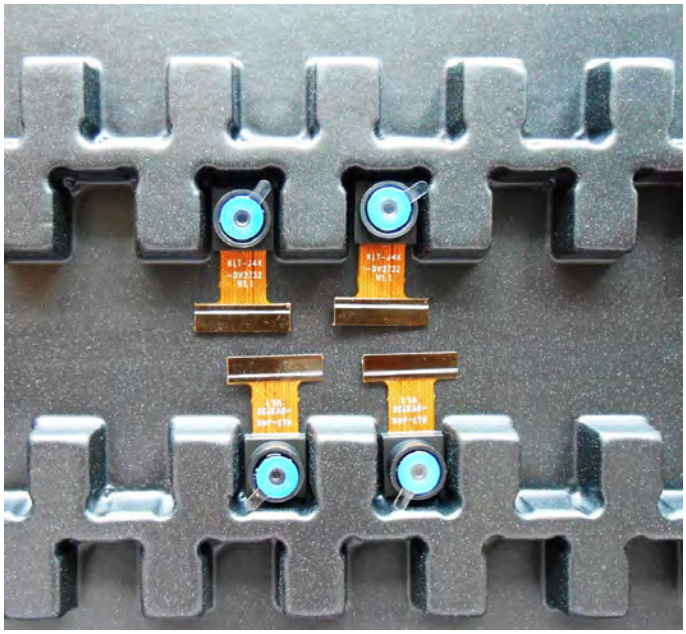
KLT Camera Module



Complete with Lens Protection Film

Tray with Grid and Space

Place Cameras on the Tray



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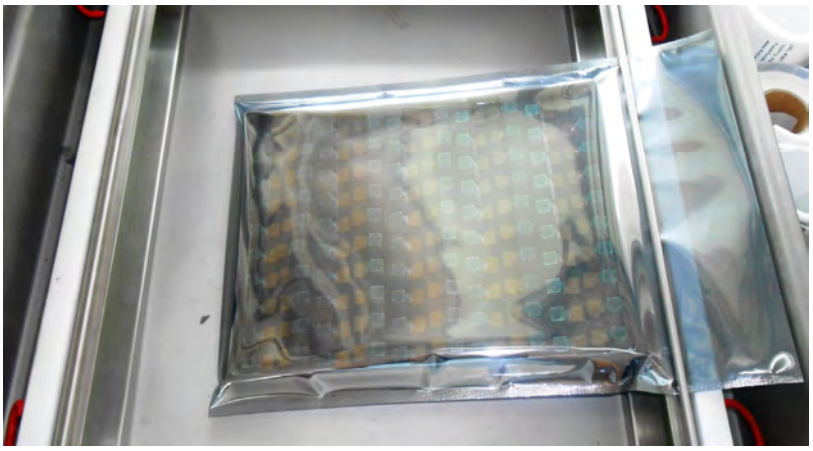
Camera Modules Package Solution

Full Tray of Cameras

Cover Tray with Lid

Put Tray into Anti-Static Bag

Vacuum the Anti-Static Bag



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Camera Modules Package Solution

Sealed Vacuum Bag with Labels
1. Model and Description 2. Quantity 3. Shipping Date 4. Caution

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Large Order Package Solution

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays

Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting Box

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Small Order Package Solution

Place Foam Sheets and Trays into Small Box

Foam Sheets are Nicely Fitting the Small Box

Package in Small Box for Shipment

Place Small Boxes into Larger Box

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Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box

Carbon Box Ready for Shipment
1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution

Sample Order Package Solution

Place Sample into Small Anti-Static Bag

Place Connectors into Small Ant-Static Bag

Sample Labels on the Small Bag
1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution

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Connectors Large Order Package Solution

Connectors in a Wheel

Label Connectors in the Wheel

The Wheel is Perfectly Fitting the Box

Connectors Box Ready for Shipment

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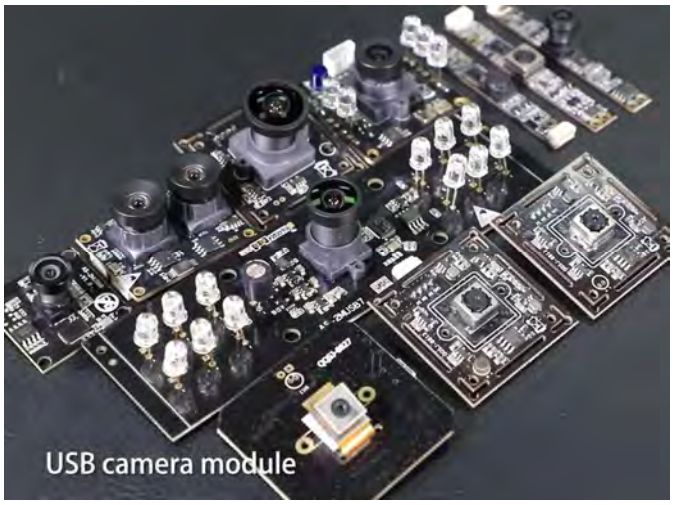
Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequential events.

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KLT Strength

Powerful Factory

Professional Service

Promised Delivery

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